

**AMENDMENTS TO THE SPECIFICATION**

**Please rewrite the Title of the Application as follows:**

~~Improved Metal During Pattern for Memory Devices~~ Improved Metal Wiring Pattern for Memory Devices.

**Please insert the following paragraph immediately following the title of the application:**

**--CROSS REFERENCE TO RELATED APPLICATIONS**

The present application is a divisional application of United States Patent Application No. 09/805,913, filed on March 15, 2001, the disclosure of which is herewith incorporated by reference in it's entirety.--